

#### SSCP006GN2

### **High Frequency High Gain PNP Power BJT**

#### Features

VCE	VBE	VCESAT Typ.	IC
-40V	-6V	-150mV	-3A

### > Description

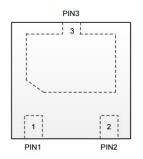
This device is produced with advanced high carrier density technology, which is especially used to minimize saturation voltage drop. This device particularly suits low voltage applications such as portable equipment, power management and other battery powered circuits, and low in-line power dissipation are needed in a very small outline surface mount package. Excellent thermal and electrical capabilities.

### Applications

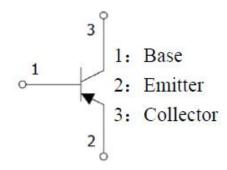
- Battery powered circuits
- Low in-line power dissipation circuits
- Power regulator

### Pin configuration

Top view



DFN2X2





Marking

## > Ordering Information

Device	Package	Shipping
SSCP006GN2	DFN2X2	3000/Reel



## ➤ Absolute Maximum Ratings(T<sub>A</sub>=25°C unless otherwise specified)

Symbol	Parameter	Ratings	Unit	
V <sub>CBO</sub>	Collector-Base Voltage	-40	V	
V <sub>CEO</sub>	Collector-Emitter Voltage -40		V	
$V_{EBO}$	Emitter-Base Voltage	-6	V	
1	Collector Current@Note1	-3	A	
lc	Collector Current@Note2	-2		
I <sub>CM</sub>	Pulsed Collector Current@Note3	-6	Α	
P <sub>D</sub>	Power Dissipation@Note1	3.0	W	
FD	Power Dissipation@Note2	1.5		
T <sub>A</sub>	Operation Temperature Range	-40 to 85	°C	
T∟	Lead Temperature	260	°C	
T <sub>J</sub> ,T <sub>STG</sub>	Operation and Storage temperature range	-55 to 150	°C	

# > Thermal Resistance Ratings

Symbol	Parameter	Maximum	Unit
В	Junction-to-Ambient Thermal		
R <sub>0JA</sub>	Resistance@Note1	45	- °C/W
В	Junction-to-Ambient Thermal	00	
$R_{ heta JA}$	Resistance@Note2	86	



# ➤ Electronics Characteristics(T<sub>A</sub>=25°C unless otherwise specified)

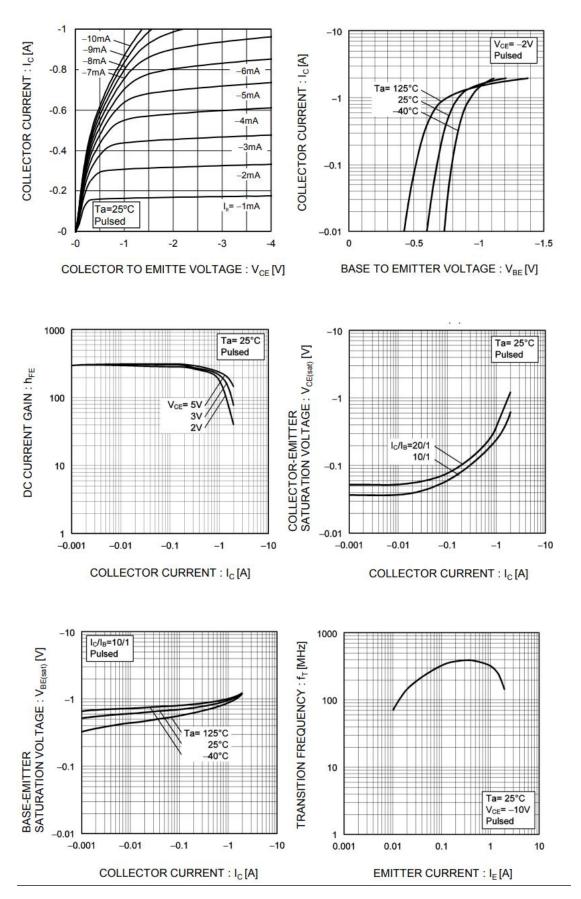
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
BVCBO	Collector-Base	IC=-100uA	-40			V
	Breakdown Voltage	IE=0	-40			V
BVCEO	Collector-Emitter	IC=-1mA	-40			V
BVCEO	Breakdown Voltage	IB=0	-40			V
BVEBO	Emitter-Base	IE=-100uA				V
BVEBU	Breakdown Voltage	IC=0	-6			V
ICBO	Collector cut off	VCB=-30V		0.1	0.1	uA
ICBO	current	IE=0			-0.1	
IED 0	Emitter cut off	VEB=-5V			-0.1	uA
IEBO	current	IC=0				
HFE	DC Current	VCE=-2V	100		100 400	
HFE	Gain@Note3	IC=-0.5A	100		400	
VCESAT	Collector-Emitter	IC=-1.5A		0.0		V
VCESAI	Saturation Voltage	IB=-80mA	-0.2		-0.2	
VBESAT	Base-Emitter	IC=-1.5A		4		
	Saturation Voltage	IB=-80mA			-1.2	V
f⊤	Transition frequency	VCE=-5V, IE=-0.1A	50	50 80		MHz
	f=10MHz		30	00		IVI□∠

#### Notes:

- Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper.
- 2. Surface mounted on FR-4 Board using minimum pad size, 1oz copper.
- 3. Pulse width=300us, Duty Cycle<2%.

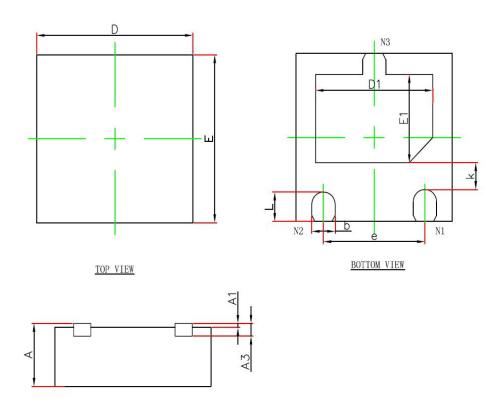


## > Typical Performance Characteristics





## Package Information



SIDE VIEW

Symbol	Dimensions In Millimeters		
	Min.	Max.	
Α	0.550	0.650	
A1	0.000	0.050	
A3	0.152REF.		
D	1.924	2.076	
Е	1.924	2.076	
D1	1.400	1.600	
E1	0.950	1.150	
K	0.220MIN.		
b	0.250	0.350	
е	1.30(BSC)		
L	0.330	0.430	



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